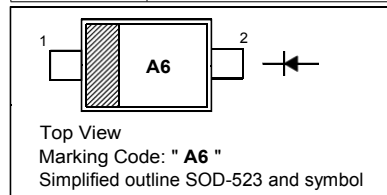


PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



**FEATURES**

- High-Speed Switching Applications
- Lead Finish: 100% Matte Sn ( Tin)
- Qualified Reflow Temperature: 260 °C
- Extremely Small SOD-523 Package

**MARKING: A6**

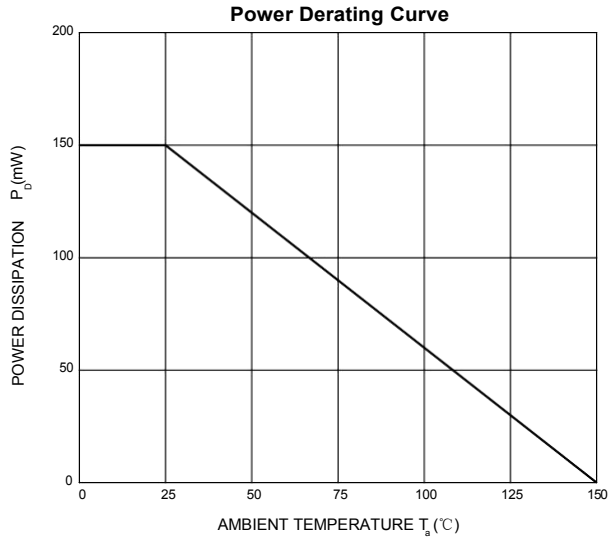
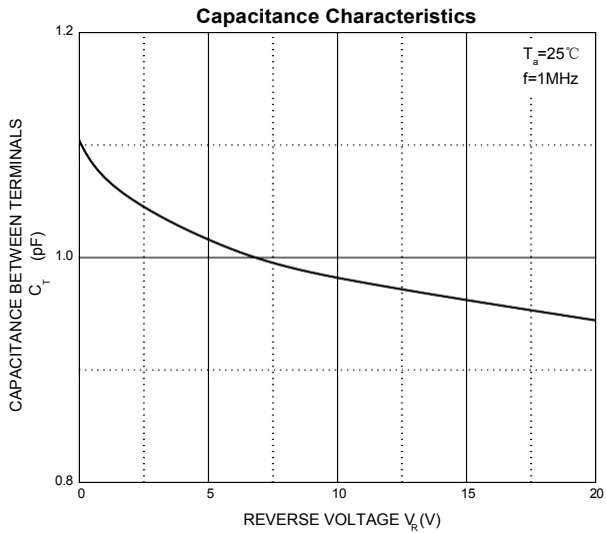
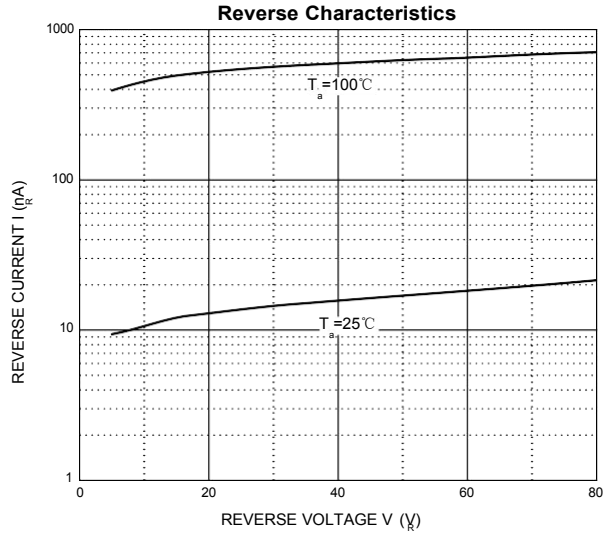
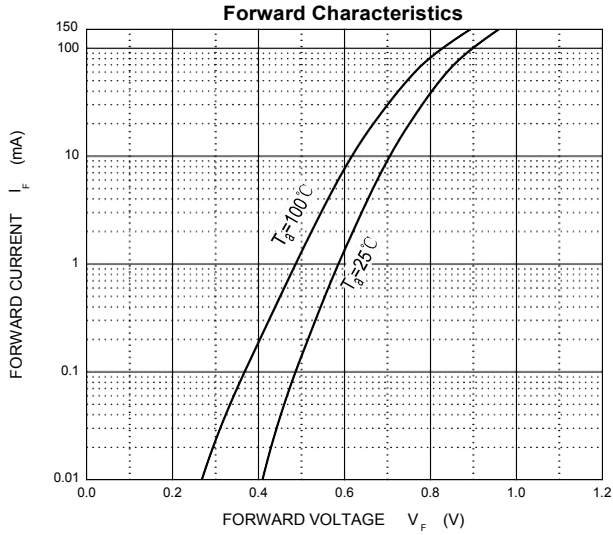
**Maximum Ratings and Electrical Characteristics, Single Diode @Ta=25°C**

Parameter	Symbol	Limit	Unit
DC Reverse Voltage	$V_R$	75	V
Forward Current	$I_F$	200	mA
Pak Forward Surge Current	$I_{FM(surge)}$	500	mA
Total Device Dissipation	$P_D$	150	mW
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	$T_j, T_{stg}$	150	°C

**Electrical Ratings @Ta=25°C**

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Reverse breakdown voltage	$V_{(BR)}$	75				$I_R=100\mu A$
Forward voltage	$V_{F1}$			715	mV	$I_F=1mA$
	$V_{F2}$			855		$I_F=10mA$
	$V_{F3}$			1000		$I_F=50mA$
	$V_{F4}$			1250		$I_F=150mA$
Reverse recovery Time	$t_{rr}$			6.0	ns	$I_F=I_R=10mA_{dc}, R_L=50\Omega$
Reverse current	$I_R$			1.0	$\mu A$	$V_R=75V$
Forward recovery voltage	$V_{FR}$			1.75	V	$I_F=10mA, t_r=20ns$
Diode capacitance	$C_D$			2.0	pF	$V_R=0V, f=1MHz$
Stored charge	$Q_s$			45	pC	$I_F=10mA, V_R=5.0V, R_L=500\Omega$

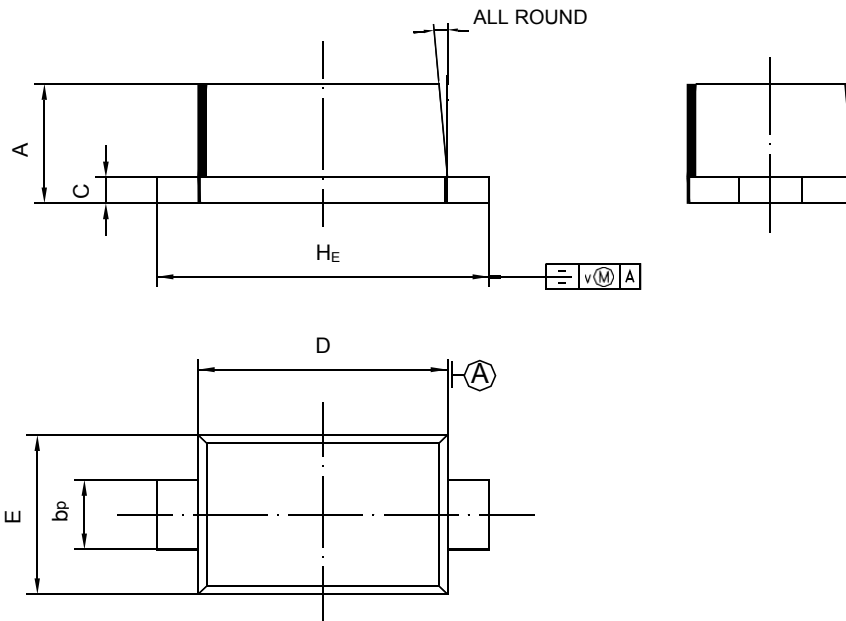
## Typical Characteristics



## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-523



UNIT	A	b <sub>p</sub>	C	D	E	H <sub>E</sub>	V	∠
mm	0.70 0.60	0.4 0.3	0.135 0.100	1.25 1.15	0.85 0.75	1.7 1.5	0.1	5°